

Features

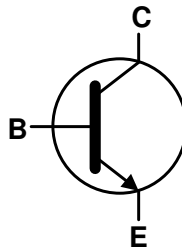
- $BV_{CEO} > 125V$
- $I_C = 800mA$ High Continuous Collector Current
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

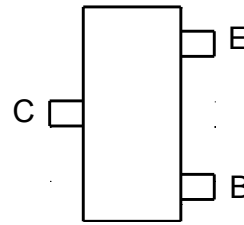
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208③
- Weight 0.008 grams (Approximate)



Top View



Device Symbol



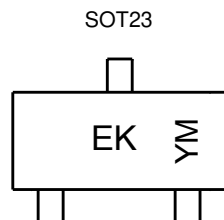
Top View
Pin-Out

Ordering Information (Note 5)

| Part Number | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity Per Reel |
|-------------|------------|---------|--------------------|-----------------|-------------------|
| BCX41TA | AEC-Q101 | EK | 7 | 8 | 3000 |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, see <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



EK = Product Type Marking Code
YM = Date Code Marking
Y or \bar{Y} = Year (ex: E = 2017)
M or \bar{M} = Month (ex: 9 = September)

Date Code Key

| Year | 2018 | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | F | G | H | I | J | K | L | M | N | O | P | Q |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 125 | V |
| Collector-Emitter Voltage | V _{CEO} | 125 | V |
| Emitter-Base Voltage | V _{EBO} | 5 | V |
| Continuous Collector Current | I _C | 800 | mA |
| Peak Pulse Current | I _{CM} | 1 | A |
| Base Current | I _B | 100 | mA |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

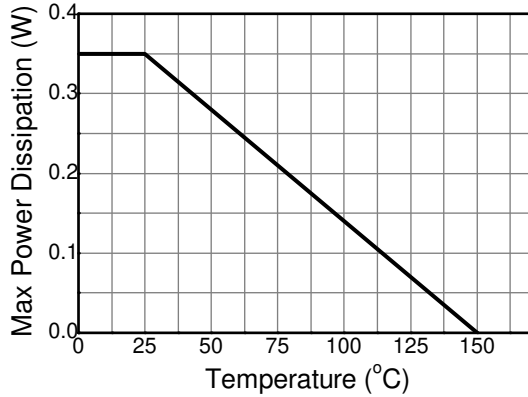
| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation | P _D | (Note 5) | 310 |
| | | (Note 6) | 350 |
| Thermal Resistance, Junction to Ambient | R _{θJA} | (Note 5) | 403 |
| | | (Note 6) | 357 |
| Thermal Resistance, Junction to Leads | R _{θJL} | 350 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

ESD Ratings (Note 8)

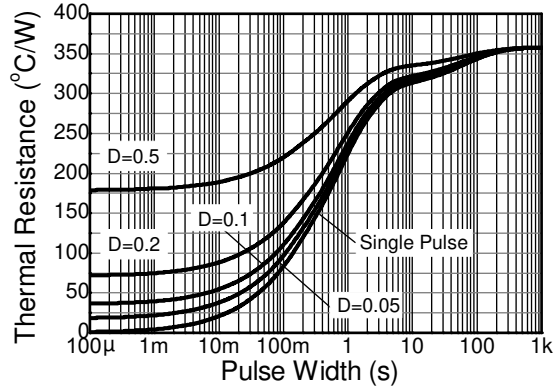
| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge—Human Body Model | ESD HBM | 4000 | V | 3A |
| Electrostatic Discharge—Machine Model | ESD MM | 400 | V | C |

- Notes:
- For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper in still air condition; the device is measured when operating in a steady-state condition.
 - Same as note (6), except the device is mounted on 15mm × 15mm FR-4 PCB.
 - Thermal resistance from junction to solder-point (at the end of the leads).
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

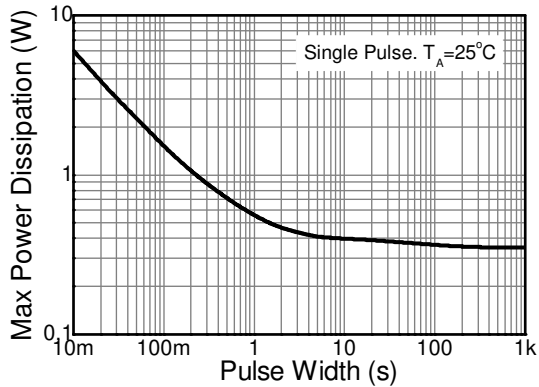
Thermal Characteristics and Derating Information (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Derating Curve



Transient Thermal Impedance



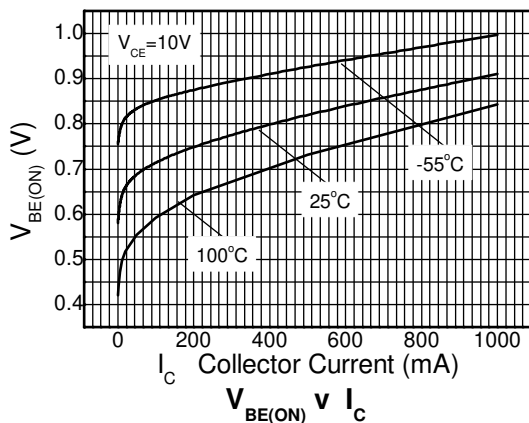
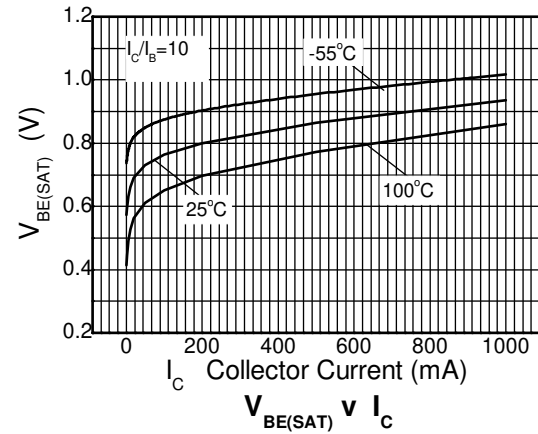
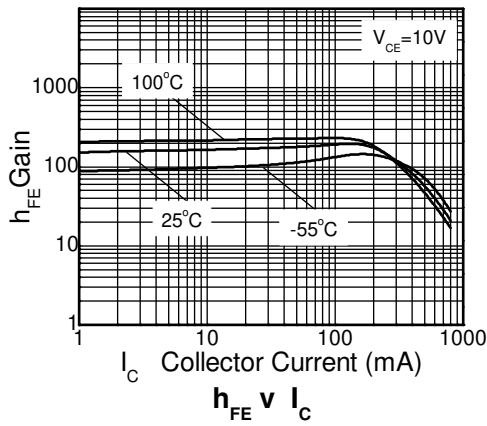
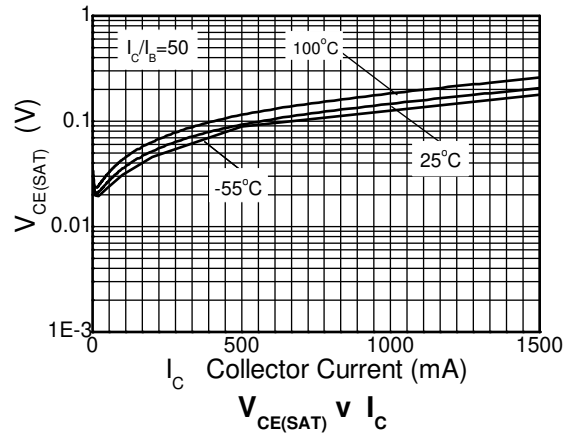
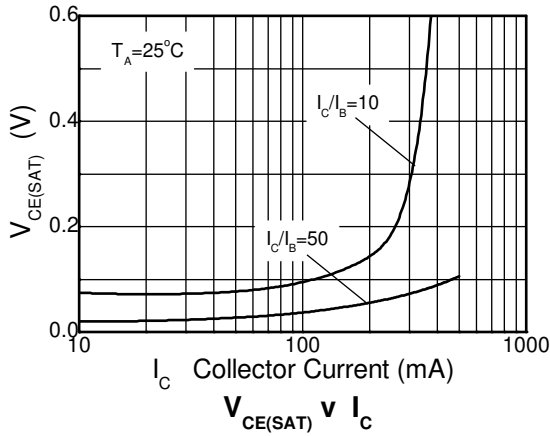
Pulse Power Dissipation

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--|----------------------|----------------|-----|-----------|----------|---|
| OFF CHARACTERISTICS | | | | | | |
| Collector-Emitter Breakdown Voltage | BV _{CES} | 125 | — | — | V | I _C = 100μA |
| Collector-Emitter Breakdown Voltage (Note 9) | BV _{CEO} | 125 | — | — | V | I _{CEO} = 10mA |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 7 | — | — | V | I _{EBO} = 10μA |
| Collector-Base Cut-Off Current | I _{CES} | — | — | 100 10 | nA μA | V _{CB} = 100V V _{CB} = 100V, T _A = +150°C |
| Collector Cut-Off Current | I _{CEx} | — | — | 10 75 | μA μA | V _{CE} = 100V, V _{BE} = 0.2V, T _A = +85°C V _{CE} = 100V, V _{BE} = 0.2V, T _A = +125°C |
| Emitter-base Cut-off Current | I _{EBO} | — | — | 100 | nA | V _{EB} = 5.6V |
| ON CHARACTERISTICS (Note 10) | | | | | | |
| Static Forward Current Transfer Ratio | h _{FE} | 25 63 40 | — | — | — | I _C = 100μA, V _{CE} = 1V I _C = 100mA, V _{CE} = 1V I _C = 200mA, V _{CE} = 1V |
| Collector-Emitter Saturation Voltage | V _{CE(SAT)} | — | — | 0.9 | V | I _C = 300mA, I _B = 30mA |
| Base-Emitter Saturation Voltage | V _{BE(SAT)} | — | — | 1.4 | V | I _C = 300mA, I _B = 30mA |
| SMALL SIGNAL CHARACTERISTICS (Note 9) | | | | | | |
| Transition Frequency | f _T | — | 100 | — | MHz | I _C = 10mA, V _{CE} = 5V, f = 20MHz |
| Output Capacitance | C _{OBO} | — | 12 | — | pF | V _{CB} = 10V, f = 1MHz |

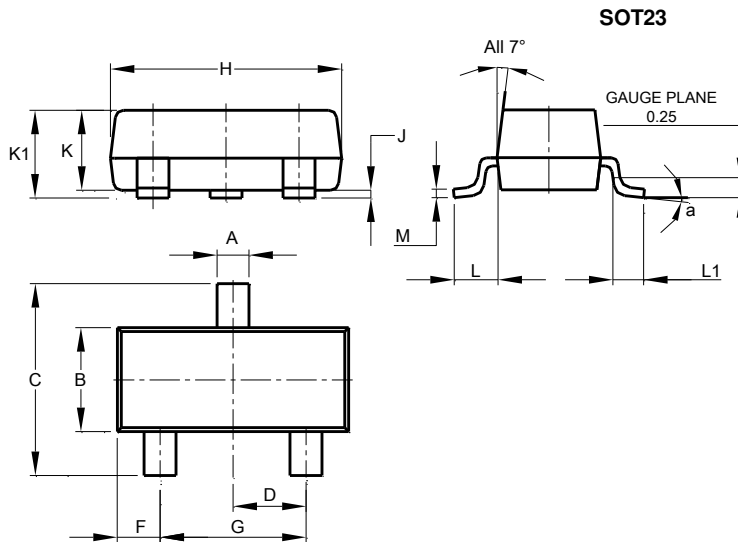
Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

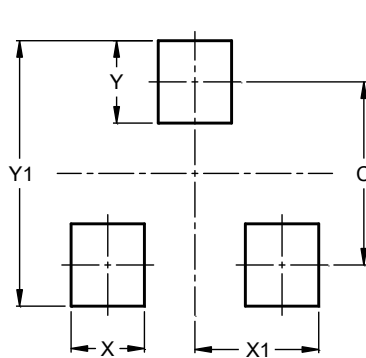
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| SOT23 | | | |
|----------------------|-------|-------|-------|
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.890 | 1.00 | 0.975 |
| K1 | 0.903 | 1.10 | 1.025 |
| L | 0.45 | 0.61 | 0.55 |
| L1 | 0.25 | 0.55 | 0.40 |
| M | 0.085 | 0.150 | 0.110 |
| a | 0° | 8° | — |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 2.0 |
| X | 0.8 |
| X1 | 1.35 |
| Y | 0.9 |
| Y1 | 2.9 |

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